

Surge Arrester

Material Data Sheet

| Product Class | B88069X*(Ni plated) 11/27/2023 | | | | | | | |
|--|--|---|--|---|---|---------------------------------------|-----------------------|--|
| Date | | | | | | | | |
| IMDS ID if available | | | | | | | | |
| Version | 5.01 | | | | | | | |
| Product Part (IMDS: semi component) | Material Class (IMDS: Material) | Material (Classification) VDA 231 | Substance | TMPS**) [wt%] | CAS if applicable | typical mass of material [wt-%] | Traces see 1) | |
| Active part | Ceramic | 3B | Al203 | 100 | 1344-28-1 | 41.1 | | |
| | Metal | 1C11 | Cu | 100 | 7440-50-8 | 44.4 | | |
| | Metal | 4D | W | 80 | 7440-33-7 | 12.65 | | |
| | | 15 | Cu | 20 | 7440-50-8 | | | |
| Brazing ring | Metal | 4D | Ag | 72 | 7440-22-4 | 0.81 | | |
| | Metal | 4D | Cu Ag | 28 50 | 7440-50-8 7440-22-4 | 0.21 | | |
| | IVICIAI | 40 | Cu | 50 | 7440-50-8 | 0.21 | | |
| Plating | Metal | 1C14 | Ni | 100 | 7440-02-0 | 0.83 | | |
| | | 1.5 | 1 | 1.00 | Sum of total | 100 | | |
| sizes [mm] Ø30 X 12.4 | weight range[g] part name 35 L10-A800XP1 L10-A800XP1 L10-A800XP2 | | | | material numbers B88069X5451* B88069X5791* B88069X5461* | | | |
| Not part of a Product | Class | | | | | | | |
| Contact | Mohd Faizal Jamaludi | n | | Important remar | Important remarks: | | | |
| Division | TDK ELECTRONICS (MALAYSIA) SDN BHD | | | 4) 7, 1, 1 | | | | |
| Address | 11 Jalan Firma 3 Tebrau Ind IV, 81100 JB Malaysia | | | The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight, if not otherwise | | | | |
| | Tel: +60-7-3566629 mailto: mohdfaizal.jamaludin@tdk.com | | | regulated. | regulated. | | | |
| *) others: .(not declarable or prohibited substances acc. GADSL) **) typical mass percentage of substance | | | | herein. We expre best present know specifications, un AFFILIATES HER WHETHER EXPI AND VALUES CO | 2) This Material Data Sheet contains typical values of the respective products set forth herein. We expressly point out that all values and statements contained herein are based on our best present knowledge and cannot be regarded as binding statements or binding product specifications, unless otherwise explicitly agreed in writing. TDK ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE. | | | |
| the European Parliame | nt and of the Council of | June 8 th , 2011 on the re | estriction of the use of certa | ain hazardous substances in | uirements according to Art. 4 (electrical and electronic equip | | rective 2011/65/EU of | |
| ■ no exemptions; □ Exemption 6 (a): L □ Exemption 6 (b): L □ Exemption 6 (c): C □ Exemption 7 (a): L □ Exemption 7 (c)-II: L □ Exemption 7 (c)-III: L □ Exemption 7 (c)-III: L | ead as an alloying element ead as an alloying element Copper alloy containing up the ead in high melting temper Electrical and electronic cor- ead in dielectric ceramic in ead in dielectric ceramic in | t in steel for machining pur t in aluminium containing u o 4 % lead by weight; ature type solder (i.e. lead nponents containing lead in capacitors for a rated volt capacitors for a rated volt | o to 0,4 % lead by weight; based alloys containing 85 % a glass or ceramic other than age of 125 V AC or 250 V DC age of less than 125 V AC or 2 | containing up to 0,35 % lead by by weight or more lead); a dielectric ceramic in capacitors or higher; | , e.g. piezoelectronic devices, or in | a glass or ceramic matrix comp | oound; | |